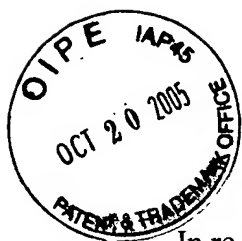


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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Art Unit: 1765
Examiner: Lan Vinh

In re PATENT APPLICATION of:

Applicant : Toyokazu SAKATA)
Serial No. : 10/721,260)
Filed : November 26, 2003)
For : ETCHING METHOD AND)
SEMICONDUCTOR DEVICE)
FABRICATING METHOD)
Attorney Ref. : TAI 145)

AMENDMENT

October 20, 2005

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This is responsive to the Office Action of July 20, 2005, the period for reply to which has been set to expire on October 20, 2005.

A fee of \$ None is being submitted concurrently. Should this remittance be accidentally missing, however, or should any additional fees be needed (including extension of time fees, since Applicant hereby provisionally petitions for any extensions that may be deemed necessary to avoid abandonment), the Director may charge such fees to our Deposit Account number 18-0002.

Please amend the above-identified application as specified on the following pages, and then reconsider the application in view of the Remarks that are presented thereafter.

FEE ENCLOSED: \$
Please charge any further
fee to our Deposit Account
No. 18-0002